

STN83003

High voltage fast-switching NPN power transistor

General features

- Medium voltage capability
- Low spread of dynamic parameters
- Minimum lot-to-lot spread for reliable operation
- Very high switching speed
- SOT-223 plastic package for surface mounting circuits
- Tape and reel packing

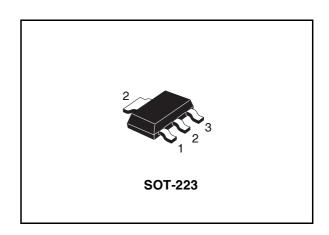
Applications

- Electronics ballasts for fluorescent lighting
- Switch mode power supplies

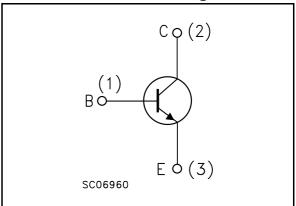
Description

The device is manufactured using high voltage Multi-Epitaxial Planar technology for high switching speeds and medium voltage capability. It uses a Cellular Emitter structure with planar edge termination to enhance switching speeds while maintaining the wide RBSOA.

The STN83003 is expressly designed for a new solution to be used in compact fluorescent lamps, where it is coupled with the STN93003, its complementary PNP transistor.



Internal schematic diagrams



Order codes

| Part Number | Marking | Package | Packing |
|-------------|---------|---------|-------------|
| STN83003 | N83003 | SOT-223 | Tape & reel |

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1 Electrical ratings

Table 1. Absolute maximum rating

| Symbol | Parameter | Value | Unit |
|------------------|---|----------------------|------|
| V _{CES} | Collector-emitter voltage (V _{BE} = 0) | 700 | V |
| V _{CEO} | Collector-emitter voltage (I _B = 0) | 400 | V |
| V _{EBO} | Emitter-base voltage $(I_C = 0, I_B = 0.75A, tp < 10\mu s, T_j < 150^{\circ}C)$ | V _{(BR)EBO} | ٧ |
| I _C | Collector current | 1.5 | Α |
| I _{CM} | Collector peak current (t _P < 5ms) | 3 | Α |
| I _B | Base current | 0.75 | Α |
| I _{BM} | Base peak current (t _P < 5ms) | 1.5 | Α |
| P _{tot} | Total dissipation at T _c = 25°C | 1.6 | W |
| T _{stg} | Storage temperature | -65 to 150 | °C |
| T _J | Max. operating junction temperature | 150 | °C |

Table 2. Thermal data

| Symbol | Parameter | Value | Unit |
|----------------------|---|-------|------|
| R _{thj-amb} | Thermal resistance junction-ambient (1) max | 78 | °C/W |

^{1.} Device mounted on PCB area of 1 cm².

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Electrical characteristics STN83003

2 Electrical characteristics

 $(T_{case} = 25^{\circ}C \text{ unless otherwise specified})$

Table 3. Electrical characteristics

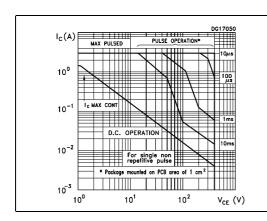
| Symbol | Parameter | Test Conditions | | Min. | Тур. | Max. | Unit |
|----------------------------------|---|--|--|---------------|-------------------|----------|----------------|
| I _{CEV} | Collector cut-off current (V _{BE} = -1.5V) | V _{CE} = 700V V _{CE} = 700V | T _j = 125°C | | | 1 5 | mA mA |
| V _{(BR)EBO} | Emitter-base breakdown voltage (I _C = 0) | I _E = 10mA | | 12 | | 18 | V |
| V _{CE(sus)} (1) | Collector-emitter sustaining voltage (I _B = 0) | I _C = 10mA L = 25mH | | 400 | | | V |
| V _{CE(sat)} (1) | Collector-emitter saturation voltage | $I_C = 0.35A$ $I_C = 0.5A$ | $I_B = 50 \text{mA}$ $I_B = 0.1 \text{A}$ | | | 1 0.5 | V V |
| V _{BE(sat)} (1) | Base-emitter saturation voltage | I _C = 0.5A | I _B = 0.1A | | | 1 | ٧ |
| h _{FE} | DC current gain | $I_{C} = 10\text{mA}$ $I_{C} = 0.35\text{A}$ $I_{C} = 1\text{A}$ | $V_{CE} = 5V$ $V_{CE} = 5V$ $V_{CE} = 5V$ | 10 16 4 | 25 | 32 | |
| t _r t _s | Resistive load Rise time Storage time Fall time | $I_{B1} = -I_{B2} = 70 \text{m}$ | V _{CC} = 125V A (see figure 10) | 1.5 | 100 2.2 0.2 | 2.9 | ns µs µs |
| t _s | Inductive load Storage time Fall time | $I_C = 0.5A$ $V_{BE(off)} = -5V$ $V_{Clamp} = 300V$ | | | 450 90 | | ns ns |

^{1.} Pulsed duration = 300 μ s, duty cycle \leq 1.5%

2.1 Electrical characteristics (curves)

Figure 1. Safe operating area

Figure 2. DC Current Gain



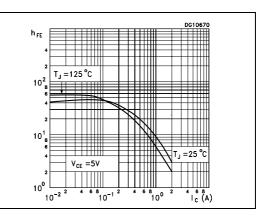
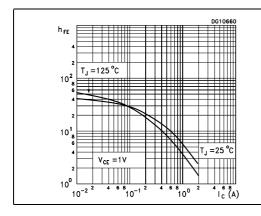


Figure 3. DC Current Gain

Figure 4. Collector-emitter saturation voltage



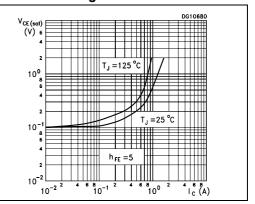
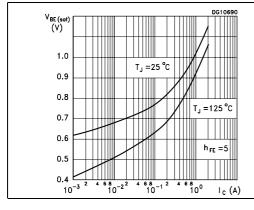
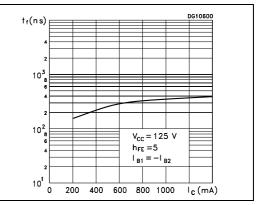


Figure 5. Base-emitter saturation voltage

Figure 6. Resistive load storage time





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Figure 7. Resistive load storage time Figure 8. Inductive load storage time

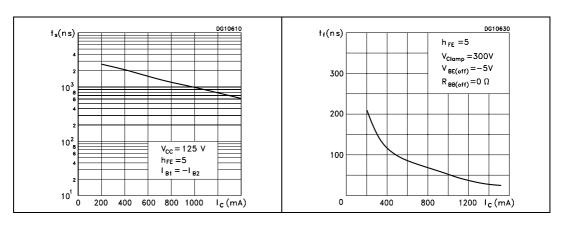
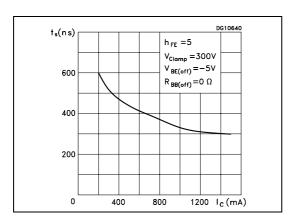


Figure 9. Inductive load fall time



2.2 Test circuits

Figure 10. Inductive load switching test circuit

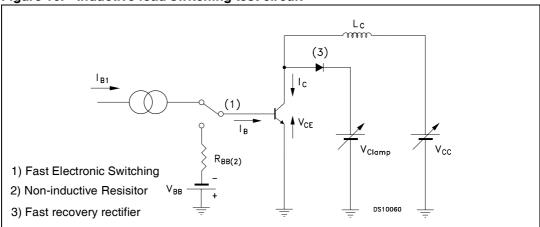
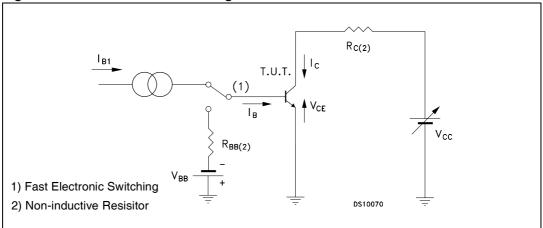


Figure 11. Resistive load switching test circuit



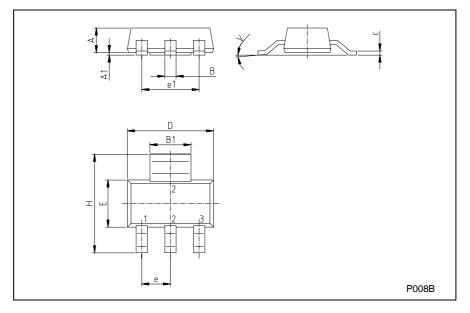
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3 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

SOT-223 MECHANICAL DATA

| DIM. | | mm | | inch | | |
|-------|------|------|------|-------|-------|-------|
| Diwi. | MIN. | TYP. | MAX. | MIN. | TYP. | MAX. |
| А | | | 1.80 | | | 0.071 |
| В | 0.60 | 0.70 | 0.80 | 0.024 | 0.027 | 0.031 |
| B1 | 2.90 | 3.00 | 3.10 | 0.114 | 0.118 | 0.122 |
| С | 0.24 | 0.26 | 0.32 | 0.009 | 0.010 | 0.013 |
| D | 6.30 | 6.50 | 6.70 | 0.248 | 0.256 | 0.264 |
| е | | 2.30 | | | 0.090 | |
| e1 | | 4.60 | | | 0.181 | |
| E | 3.30 | 3.50 | 3.70 | 0.130 | 0.138 | 0.146 |
| Н | 6.70 | 7.00 | 7.30 | 0.264 | 0.276 | 0.287 |
| ٧ | | | 10° | | | 10° |
| A1 | | 0.02 | | | | |



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Revision history STN83003

4 Revision history

Table 4. Revision history

| Date | Revision | Changes | |
|-------------|----------|---|--|
| 09-May-2006 | 1 | Initial release. | |
| 17-Jan-2007 | 2 | The device's safe operating area curve has been added on page | |

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